

CLAIMS

1. An electronic component packaging container which uses a multilayer polyester sheet comprising a base layer containing a polyethylene terephthalate type resin and a polycarbonate type resin and a surface layer containing a polycarbonate type resin, formed on at least one side of the base layer, wherein the base layer contains from 70 to 97 wt% of the polyethylene terephthalate type resin and from 3 to 30 wt% of the polycarbonate type resin based on the total amount of the polyethylene terephthalate type resin and the polycarbonate type resin, and the thickness of the surface layer is from 10 to 30% of the total thickness.
2. The electronic component packaging container according to Claim 1, wherein the multilayer polyester sheet has a total light transmittance of at least 85% and a cloudiness of at most 10%.
3. The electronic component packaging container according to Claim 1 or 2, which has an antistatic treatment applied to one or both sides.
4. A sheet which comprises a base layer containing a polyethylene terephthalate type resin and a polycarbonate type resin, a surface layer containing a polycarbonate type resin formed on at least one side of the base layer, and a coating layer of an electrically conductive coating formed on at least one side of the surface layer, wherein the base layer contains from 70 to 97 wt% of the

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SUB A1

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